



Product Summary

B340AQ:							
V _{RRM} (V)	I _O (A)	V _{F(MAX)} @ 3A (V)	I _{R(MAX)} @ V _{RRM} (mA)				
40	3.0	0.50	0.5				

Description and Applications

For use in Automotive of ECU and ABS applications.

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 5)

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte-Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.064 grams (Approximate)

SMA





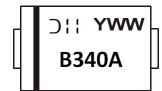
Top View

Bottom View

Ordering Information (Notes 5 & 6)

Part Number	Compliance	Case	Packaging
B340AQ-13-F	Automotive	SMA	5,000/Tape & Reel

Marking Information (Note 7)



B340A :Product Type Marking Code,) | = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 15 for 2015) WW = Week Code (01 to 53)

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 - 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - 4. Products manufactured with Date Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
 - 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 - 6. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%

Characteristic		Symbol	B340AQ	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	40	V
Average Rectified Output Current	⊉ T _T = +100°C	lo	3.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Los	ad	I _{FSM}	80	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Total Power Dissipation - Steady State, TA = +25°C (Note 8)	PD	850	mW
Typical Thermal Resistance, Junction to Ambient (Note 8)	R _{θJA}	140	°C/W
Typical Thermal Resistance, Junction to Terminal (Note 9)	R _{θJT}	25	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 9)	R _{θJA}	100	°C/W
Operating Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

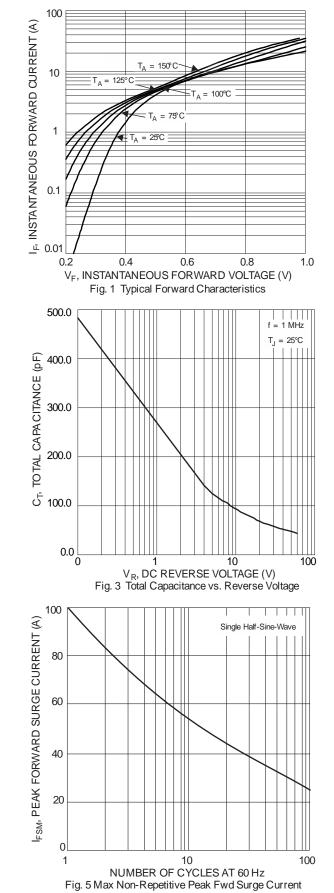
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B340AQ	VF	-	—	0.50	V	I _F = 3.0A, T _A = +25°C
			_	—	0.5	~^^	@ Rated V _R , T _A = +25°C
Leakage Current (Note 10)		IR		—	20	mA	@ Rated V _R , T _A = +100°C
Total Capacitance		CT	_	200	—	pF	$V_R = 4V, f = 1MHz$

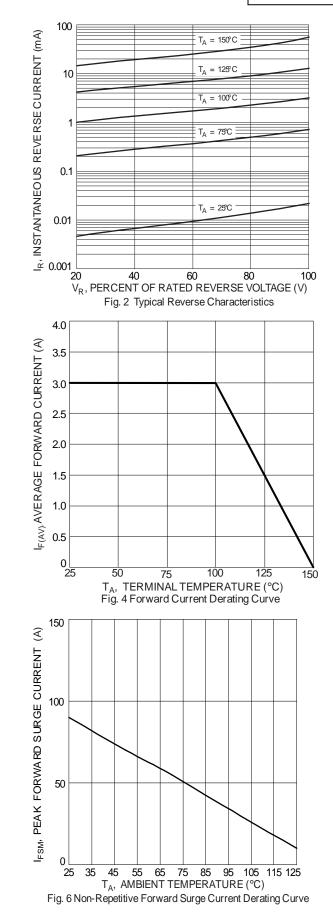
Notes:

Bevice mounted on FR-4 PCB, with minimum recommended pad layout.
Device mounted on glass epoxy substrate with 2x3mm copper pad.
Short duration pulse test used to minimize self-heating effect.











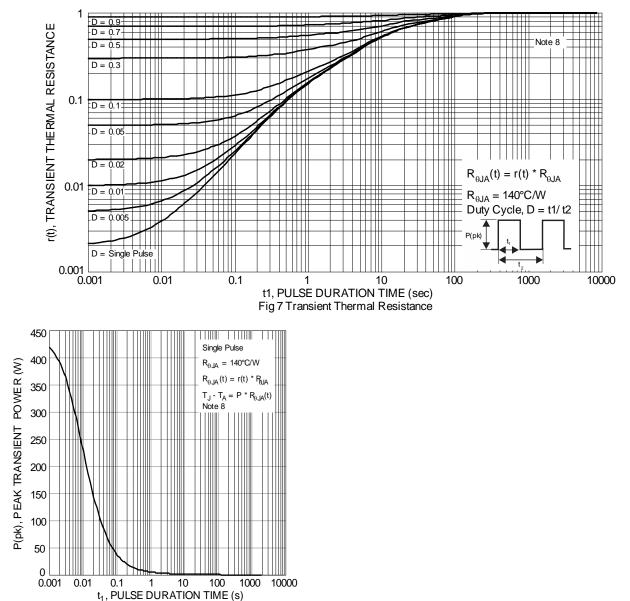


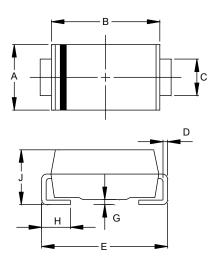
Fig. 8 Single Pulse Maximum Power Dissipation



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

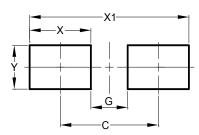
SMA



SMA					
Dim	Min	Max			
Α	2.29	2.92			
В	4.00	4.60			
С	1.27	1.63			
D	0.15	0.31			
Е	4.80	5.59			
G	0.05	0.20			
Н	0.76	1.52			
J	1.96	2.40			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	4.00		
G	1.50		
Х	2.50		
X1	6.50		
Y	1.70		

SMA



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